# MM5Z2V4ST1 SERIES

# **Zener Voltage Regulators**

## 200 mW SOD-523 Surface Mount

This series of Zener diodes is packaged in a SOD-523 surface mount package. They are designed to provide voltage regulation protection and are especially attractive in situations where space is at a premium. They are well suited for applications such as cellular phones, hand held portables, and high density PC boards.

## **Specification Features**

- Standard Zener Breakdown Voltage Range -2.4 V to 18 V
- Steady State Power Rating of 200 mW
- Small Body Outline Dimensions: 0.047" x 0.032" (1.20 mm x 0.80 mm)
- Low Body Height: 0.028" (0.7 mm)
- ESD Rating of Class 3 (>16 kV) per Human Body Model
- Tight Tolerance V<sub>Z</sub>
- These are Pb–Free Devices

**Mechanical Characteristics CASE:** Void-free, transfer-molded, thermosetting plastic Epoxy Meets UL 94, V-0 LEAD FINISH: 100% Matte Sn (Tin) **MOUNTING POSITION:** Any **QUALIFIED MAX REFLOW TEMPERATURE: 260°C Device Meets MSL 1 Requirements** 

## MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Total Device Dissipation FR–5 Board, (Note 1) @ $T_A = 25^{\circ}C$ Derate above 25°C	P <sub>D</sub>	200 1.5	mW mW/°C
Thermal Resistance from Junction-to-Ambient	$R_{\thetaJA}$	635	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C

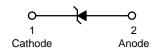
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-4 Minimum Pad.



## **ON Semiconductor®**

http://onsemi.com





SOD-523 **CASE 502** PLASTIC

#### MARKING DIAGRAM



XX = Specific Device Code Μ Date Code\*

= Pb-Free Package

(Note: Microdot may be in either location) \*Date Code orientation may vary depending upon manufacturing location.

### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MM5ZxxxST1	SOD-523*	3000/Tape & Reel
MM5ZxxxST1G	SOD-523*	3000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*This package is inherently Pb-Free.

## **DEVICE MARKING INFORMATION**

See specific marking information in the device marking column of the Electrical Characteristics table on page 2 of this data sheet.

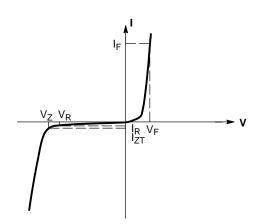
1

## MM5Z2V4ST1 SERIES

### **ELECTRICAL CHARACTERISTICS**

 $\begin{array}{l} (T_A = 25^\circ C \text{ unless otherwise noted,} \\ V_F = 0.9 \text{ V Max.} @ \text{ I}_F = 10 \text{ mA for all types)} \end{array}$ 

Symbol	Parameter					
VZ	Reverse Zener Voltage @ IZT					
I <sub>ZT</sub>	Reverse Current					
Z <sub>ZT</sub>	Maximum Zener Impedance @ IZT					
I <sub>ZK</sub>	Reverse Current					
Z <sub>ZK</sub>	Maximum Zener Impedance @ IZK					
I <sub>R</sub>	Reverse Leakage Current @ V <sub>R</sub>					
V <sub>R</sub>	Reverse Voltage					
١ <sub>F</sub>	Forward Current					
V <sub>F</sub>	Forward Voltage @ I <sub>F</sub>					
$\Theta V_Z$	Maximum Temperature Coefficient of $V_Z$					
С	Max. Capacitance $@V_R = 0$ and f = 1 MHz					



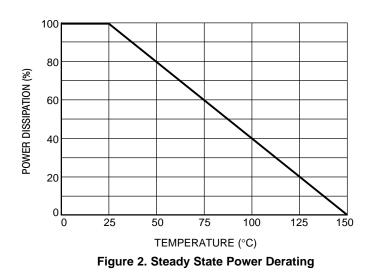


## **ELECTRICAL CHARACTERISTICS** ( $V_F = 0.9 \text{ Max} \otimes I_F = 10 \text{ mA}$ for all types)

		Test	Zener Voltage VZ		Z <sub>ZK</sub> I <sub>Z</sub> = 1.0	Z <sub>ZT</sub> I <sub>Z</sub> = IZT @ 10%	Max IR @ VR		d <sub>VZ</sub> /dt (mV/k) @ I <sub>ZT1</sub> = 5 mA		C pF Max @
Device*	Device Marking	Current Izt mA	Min	Max	mA Ω Max	Mod Ω Max	μΑ	v	Min	Max	V <sub>R</sub> = 0 f = 1 MHz
MM5Z2V4ST1	T2	5.0	2.43	2.63	1000	100	120	1.0	-3.5	0	450
MM5Z2V7ST1	Т3	5.0	2.67	2.91	1000	100	100	1.0	-3.5	0	450
MM5Z3V3ST1	T5	5.0	3.32	3.53	1000	95	5.0	1.0	-3.5	0	450
MM5Z3V6ST1	Т6	5.0	3.60	3.85	1000	90	5.0	1.0	-3.5	0	450
MM5Z3V9ST1	T7	5.0	3.89	4.16	1000	90	3.0	1.0	-3.5	-2.5	450
MM5Z4V3ST1	Т8	5.0	4.17	4.43	1000	90	3.0	1.0	-3.5	0	450
MM5Z4V7ST1	Т9	5.0	4.55	4.75	800	80	3.0	2.0	-3.5	0.2	260
MM5Z5V1ST1	TA	5.0	4.98	5.2	500	60	2.0	2.0	-2.7	1.2	225
MM5Z5V6ST1	TC	5.0	5.49	5.73	200	40	1.0	2.0	-2.0	2.5	200
MM5Z6V2ST1	TE	5.0	6.06	6.33	100	10	3.0	4.0	0.4	3.7	185
MM5Z6V8ST1	TF	5.0	6.65	6.93	160	15	2.0	4.0	1.2	4.5	155
MM5Z7V5ST1	TG	5.0	7.28	7.6	160	15	1.0	5.0	2.5	5.3	140
MM5Z8V2ST1	TH	5.0	8.02	8.36	160	15	0.7	5.0	3.2	6.2	135
MM5Z9V1ST1	ТК	5.0	8.85	9.23	160	15	0.5	6.0	3.8	7.0	130
MM5Z12VST1	TN	5.0	11.74	12.24	80	25	0.1	8.0	6.0	10	130
MM5Z16VST1	TU	5.0	15.85	16.51	80	40	0.05	11.2	10.4	14	105
MM5Z18VST1	TW	5.0	17.56	18.35	80	45	0.05	12.6	12.4	16	100

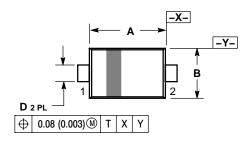
\*The "G" suffix indicates Pb-Free package available.

## **MM5Z2V4ST1 SERIES**



### PACKAGE DIMENSIONS

SOD-523 CASE 502-01 ISSUE B



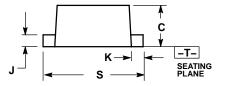
NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI

Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER.

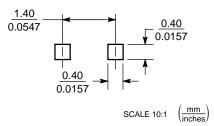
2 3

MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAI

	М	LLIMETE	RS	INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	1.10	1.20	1.30	0.043	0.047	0.051	
В	0.70	0.80	0.90	0.028	0.032	0.035	
С	0.50	0.60	0.70	0.020	0.024	0.028	
D	0.25	0.30	0.35	0.010	0.012	0.014	
J	0.07	0.14	0.20	0.0028	0.0055	0.0079	
K	0.15	0.20	0.25	0.006	0.008	0.010	
S	1.50	1.60	1.70	0.059	0.063	0.067	



#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and 💷 are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT

Literature Distribution Center for ON Semiconductor P.O. Box 61312, Phoenix, Arizona 85082-1312 USA Phone: 480-829-7710 or 800-344-3860 Toll Free USA/Canada Fax: 480-829-7709 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Japan: ON Semiconductor, Japan Customer Focus Center 2-9-1 Kamimeguro, Meguro-ku, Tokyo, Japan 153-0051 Phone: 81-3-5773-3850

ON Semiconductor Website: http://onsemi.com

Order Literature: http://www.onsemi.com/litorder

For additional information, please contact your local Sales Representative.